PDFN3.3X3.3-8 N Channel Enhancement 沟道增强型
MOS Field Effect Transistor 场效应管

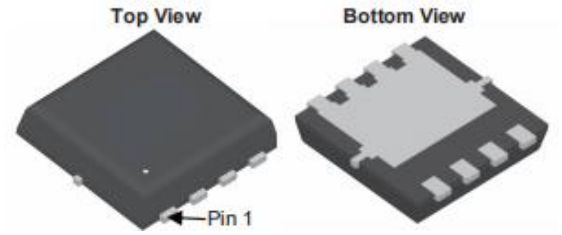
■Features 特点

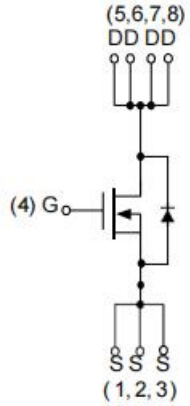
Low on-resistance 低导通电阻
$R_{DS(ON)}$=16mΩ(Type)@V_{GS}=10V
$R_{DS(ON)}$=21mΩ(Type)@V_{GS}=4.5V

■Applications 应用

Load Switch 负载开关
Portable Equipment 桌面设备
Power Management 电源管理

■Internal Schematic Diagram 内部结构





■Absolute Maximum Ratings 最大额定值

Characteristic 特性参数	Symbol 符号	Rat 额定值	Unit 单位
Drain-Source Voltage 漏极-源极电压	BV_{DSS}	30	V
Gate- Source Voltage 栅极-源极电压	V_{GS}	±20	V
Drain Current (continuous)漏极电流-连续	I_D（at T_C = 25°C at T_A = 25°C）	23 8	A
Drain Current (pulsed)漏极电流-脉冲	I_{DM}	28	A
Total Device Dissipation 总耗散功率	P_{TOT}(at T_C = 25°C at T_A = 25°C)	17.8 1.56	W
Avalanche Energy(Single Pulse)雪崩能量	E_{AS}	12	mJ
Thermal Resistance Junction-Ambient 热阻	$R_{\Theta JC}$/$R_{\Theta JA}$	7/80	℃/W
Junction/Storage Temperature 结温/储存温度	T_J,T_{stg}	-55~150	℃

■Electrical Characteristics 电特性

(T_A=25℃ unless otherwise noted 如无特殊说明，温度为 25℃)

Characteristic 特性参数	Symbol 符号	Min 最小值	Typ 典型值	Max 最大值	Unit 单位
Drain-Source Breakdown Voltage 漏极-源极击穿电压(I_D =250uA,V_{GS}=0V)	BV_{DSS}	30	—	—	V
Gate Threshold Voltage 栅极开启电压(I_D =250uA,V_{GS}= V_{DS})	$V_{GS(th)}$	1.4	1.8	2.5	V
Zero Gate Voltage Drain Current 零栅压漏极电流(V_{GS}=0V, V_{DS}= 24V)	I_{DSS}	—	—	1	uA
Gate Body Leakage 栅极漏电流(V_{GS}=±20V, V_{DS}=0V)	I_{GSS}	—	—	±100	nA
Static Drain-Source On-State Resistance 静态漏源导通电阻(I_D=8A,V_{GS}=10V) (I_D=5A,V_{GS}=4.5V)	$R_{DS(ON)}$	—	16 21	21 26	mΩ
Diode Forward Voltage Drop 内附二极管正向压降(I_{SD}=1A,V_{GS}=0V)	V_{SD}	—	0.75	1.1	V
Input Capacitance 输入电容 (V_{GS}=0V, V_{DS}=15V,f=1MHz)	C_{ISS}	—	415	—	pF
Common Source Output Capacitance 共源输出电容(V_{GS}=0V, V_{DS}=15V,f=1MHz)	C_{OSS}	—	70	—	pF
Reverse Transfer Capacitance 反馈电容 (V_{GS}=0V, V_{DS}=15V,f=1MHz)	C_{RSS}	—	40	—	pF
Total Gate Charge 栅极电荷密度 (V_{DS}=15V, I_D=8A, V_{GS}=4.5V)	Q_g	—	8	—	nC
Gate Source Charge 栅源电荷密度 (V_{DS}=15V, I_D=8A, V_{GS}=4.5V)	Q_{gs}	—	2	—	nC
Gate Drain Charge 栅漏电荷密度 (V_{DS}=15V, I_D=8A, V_{GS}=4.5V)	Q_{gd}	—	3	—	nC
Turn-ON Delay Time 开启延迟时间 (V_{DS}=15V I_D=1A, R_{GEN}=6Ω,V_{GS}=10V)	$t_{d(on)}$	—	6	—	ns
Turn-ON Rise Time 开启上升时间 (V_{DS}=15V I_D=1A, R_{GEN}=6Ω,V_{GS}=10V)	t_r	—	9	—	ns
Turn-OFF Delay Time 关断延迟时间 (V_{DS}=15V I_D=1A, R_{GEN}=6Ω,V_{GS}=10V)	$t_{d(off)}$	—	14	—	ns
Turn-OFF Fall Time 关断下降时间 (V_{DS}=15V I_D=1A, R_{GEN}=6Ω,V_{GS}=10V)	t_f	—	4	—	ns

■Typical Characteristic Curve 典型特性曲线

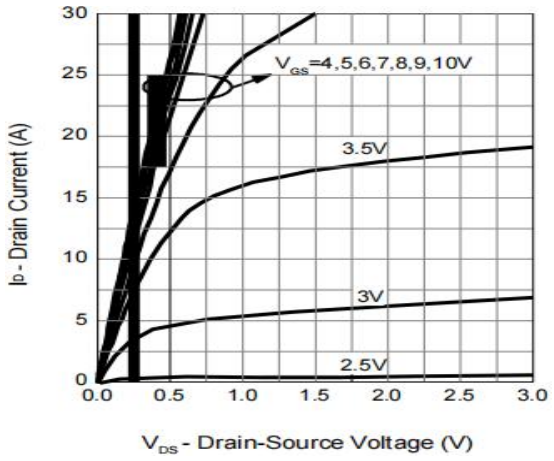


Figure 1: Output Characteristics

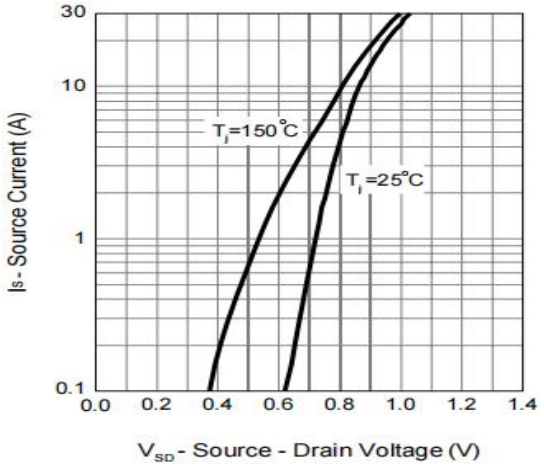


Figure 2: Diode Forward Characteristics

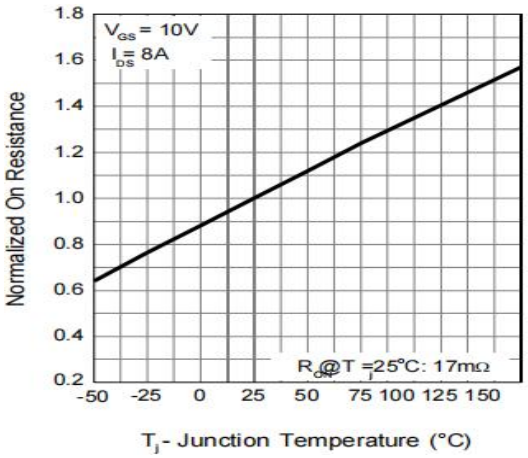


Figure 3: On-Resistance vs. T_J

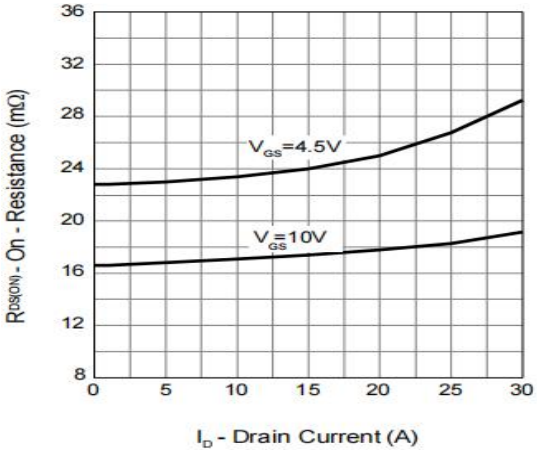


Figure 4: On-Resistance vs. Drain Current

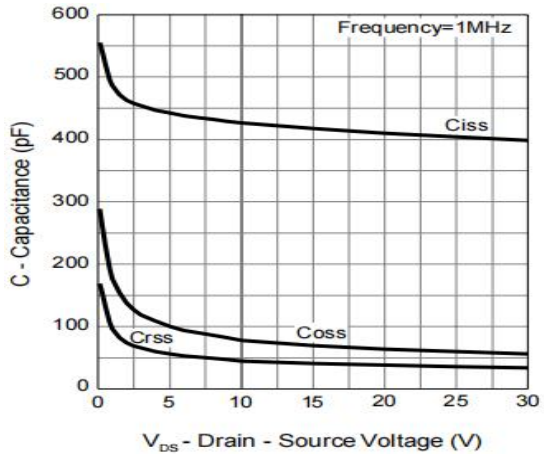


Figure 5: Capacitance Characteristics

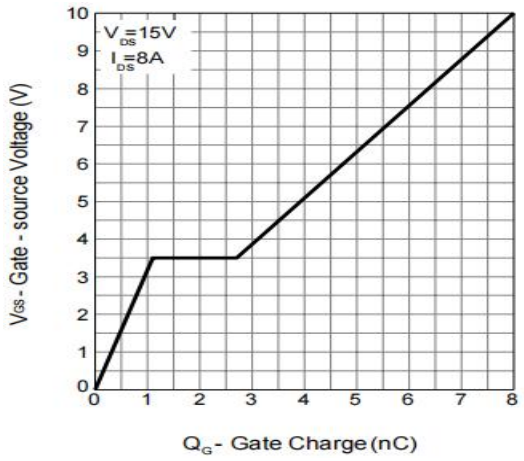


Figure 6: Gate-Charge Characteristics

■Typical Characteristic Curve 典型特性曲线

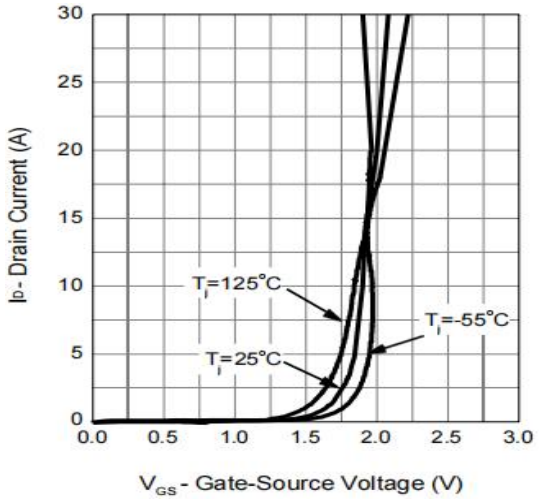


Figure 7: Transfer Characteristics

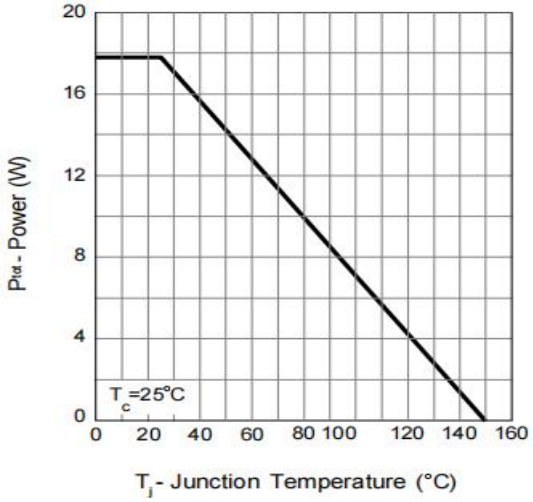


Figure 8: Power Rating Curve

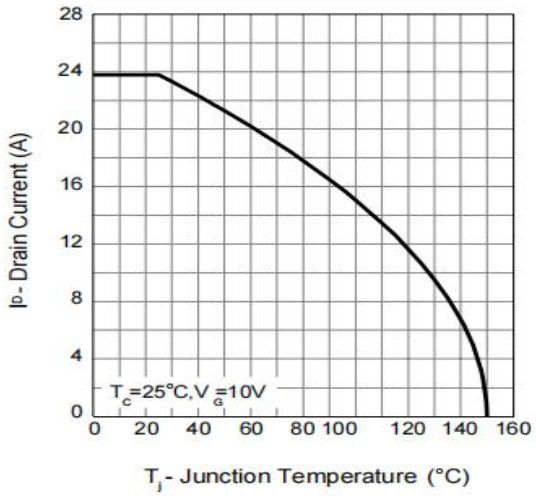


Figure 9: Drain Current Characteristics

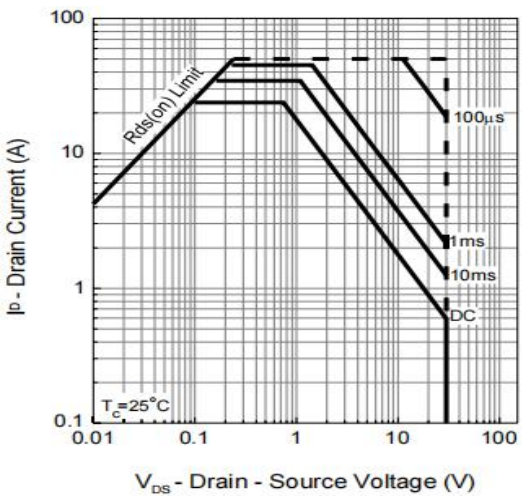


Figure 10: Safe Operating Area

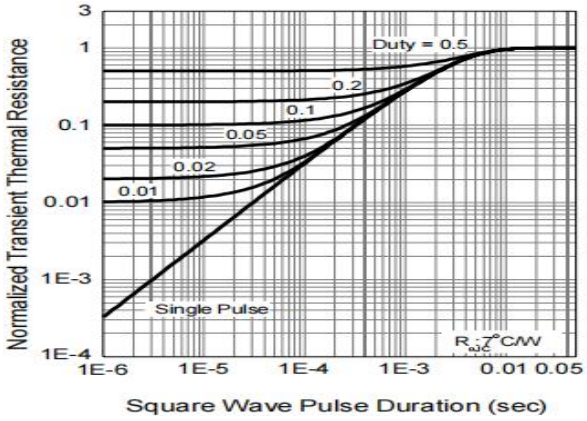
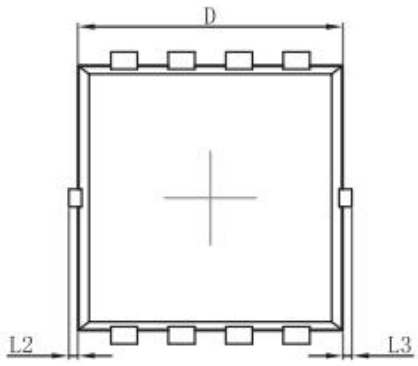
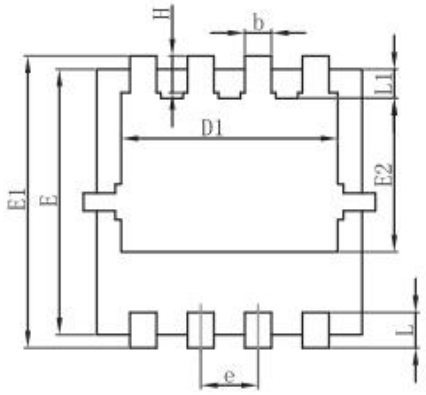


Figure 11: Transient Thermal Response Curve

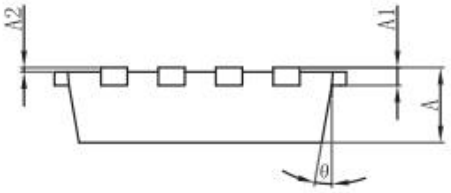
■ Dimension 外形封装尺寸



Top View



Bottom View



Side View

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.650	0.850	0.026	0.033
A1	0.152 REF.		0.006 REF.	
A2	0~0.05		0~0.002	
D	2.900	3.100	0.114	0.122
D1	2.300	2.600	0.091	0.102
E	2.900	3.100	0.114	0.122
E1	3.150	3.450	0.124	0.136
E2	1.535	1.935	0.060	0.076
b	0.200	0.400	0.008	0.016
e	0.550	0.750	0.022	0.030
L	0.300	0.500	0.012	0.020
L1	0.180	0.480	0.007	0.019
L2	0~0.100		0~0.004	
L3	0~0.100		0~0.004	
H	0.315	0.515	0.012	0.020
θ	9°	13°	9°	13°